

Article

# Ultra-Low-Loss Silicon Waveguides for Heterogeneously Integrated Silicon/III-V Photonics

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**Featured Application:** Ultra-low-loss Si waveguide platform for heterogeneous integration with III/V.

**Abstract:** Integrated ultra-low-loss waveguides are highly desired for integrated photonics to enable applications that require long delay lines, high-Q resonators, narrow filters, etc. Here we present an ultra-low-loss silicon waveguide on 500 nm thick SOI platform. Meter-scale delay lines, million-Q resonators and tens of picometer bandwidth grating filters are experimentally demonstrated. We design a low-loss low-reflection taper to seamlessly integrate the ultra-low-loss waveguide with standard heterogeneous Si/III-V integrated photonics platform to allow realization of high-performance photonic devices such as ultra-low-noise lasers and optical gyroscopes.

**Keywords:** ultra-low-loss waveguide; silicon photonics; heterogeneous integration; narrow linewidth lasers; high Q resonators.

## 1. Introduction

Photonic integration promises significant improvement in performance, reliability and SWaP-C (size, weight, power and cost) due to integration of components, reduced coupling losses and reduced sensitivity to environmental perturbation. Photonic integrated circuits (PICs) have been demonstrated in various material systems such as GaAs, InP, Si, Si<sub>3</sub>N<sub>4</sub>, LiNbO<sub>3</sub> with various levels of functionality [1–5]. An ideal platform would combine the efficiency of electrically pumped optical sources available in GaAs and InP systems, with high-contrast superior waveguide structures available in Si and ultra-low-loss waveguides available in e.g. Si<sub>3</sub>N<sub>4</sub> platform.

Heterogeneous silicon photonics is a very attractive platform for photonic integration as it combines the best of what Si and III-V platforms can offer and provide many kinds of high-performing passive and active optical devices on a single chip [6]. High-performing, large-scale PICs for communication and sensing applications have been successfully demonstrated [7–10]. The high index contrast waveguide formed between Si and its native oxide (SiO<sub>2</sub>) allows for small waveguides and tight bends enabling very compact photonic devices with small footprint. However, the high index contrast also results in relatively high propagation loss mainly dominated by scattering. This limits the performance of devices requiring on-chip delays larger than a few centimeters. Typical propagation loss of single-mode Si wire waveguides range from 0.5 dB/cm to 2 dB/cm [11–13], and the lower number requires advanced immersion 193 nm lithography, which currently might not be as widely available in silicon photonics.

When it comes to applications that demand very low propagation loss, such as optical buffer technology [14] or interferometric waveguide coil optical gyroscopes [15], other dielectric platforms with lower index contrast are often preferable [16–19]. Davenport et al. has demonstrated the possibility of incorporating the Si, III-V, and ultra-low loss (4.2 dB/m) Si<sub>3</sub>N<sub>4</sub> waveguides on the same chip [20]. The downside of this approach, however, is the increased complexity of the fabrication, which involves an extra bonding step and planarization. It is advantageous to follow a simpler path to ultra-low-loss waveguides that can provide higher yield and low cost, while maintaining compatibility with III-V heterogeneous integration. The most straightforward approach to achieve

this is to make lower loss waveguides directly in silicon, using the rib waveguide geometry as opposed to a fully etched wire geometry. It has been shown that a propagation loss as low as 2.7 dB/m could be achieved with a 200 nm rib on 1  $\mu\text{m}$  thick silicon waveguide [21].

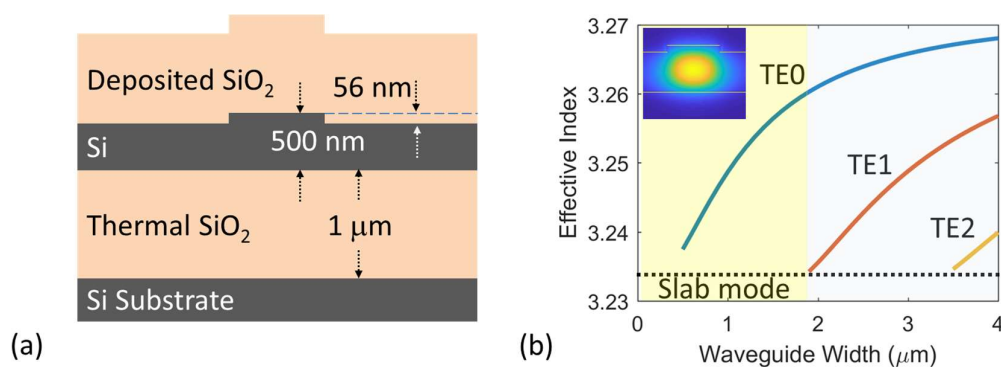
Single-mode Si wire waveguides using 220 nm thick silicon wires are commonly used in silicon photonics. However, applications that require coupling to III-V gain perform better with thicker (500 nm) waveguides [22] that are shallowly etched. In this paper, we report on shallow rib silicon waveguides with a propagation loss as low as 4 dB/m that can be incorporated into the heterogeneous Si/III-V platform with only one additional lithography and etch step. We utilize these ultra-low loss silicon waveguides to form long optical spiral delay lines, high quality-factor (Q) ring resonators and low kappa ( $\kappa$ ) narrow bandwidth Bragg grating reflectors. These ultra-low loss Si waveguides offer the necessary building blocks for the heterogeneous silicon photonics platform to realize delay-line based systems on-chip, e.g. a fully integrated optical gyroscope. Furthermore, the high quality-factor resonators allow ultra-narrow optical filters and ultra-narrow linewidth lasers.

## 2. Ultra-low Loss 500 nm SOI Waveguide

In most heterogeneous silicon/III-V photonic lasers, current is injected vertically through the III-V active region and thus the III-V stack is typically about 2  $\mu\text{m}$  thick to separate the contact metal sufficiently far from the optical mode. As a result, the silicon thickness must also be as thick as 400–500 nm to match the refractive index of the III-V slab for an efficient mode hybridization in the Si/III-V waveguides [23]. The heterogeneous Si/III-V photonic design kit (PDK) developed at UCSB at 1550 nm wavelength in recent years has been built and optimized for 500 nm thick silicon on 1  $\mu\text{m}$  buried oxide on silicon substrates. The ultra low loss waveguides in our work here, therefore, is also built on the same SOI platform.

### 2.1. Waveguide Geometry

The waveguide cross-sectional geometry is shown in **Figure 1a**. To lower the optical mode interaction with the rib sidewall, the waveguide rib height is targeted to be about 10% of the total Si layer thickness. An etch depth of 56 nm was chosen because it can be accurately controlled using a laser-based interferometric etch depth monitor (Intellectrics LEP500) system, which is commercially available. Thermal oxide serves as the bottom buried oxide (BOX) while the top cladding is deposited oxide, either by PECVD or sputtering. Each cladding layer is 1  $\mu\text{m}$  thick to minimize substrate leakage or loss due to the metal heaters, which are commonly put on the top of the waveguide resonators. The effective index of the TE modes versus the waveguide width is plotted in Figure 1b, suggesting that the waveguide guides a single TE mode when the width is 1.8  $\mu\text{m}$  or lower.



**Figure 1** (a) Cross-sectional geometry of the low loss Si waveguides in this work. The thickness of the buried oxide (BOX) and the Si device layer are 1  $\mu\text{m}$  and 500 nm, respectively. The 56 nm tall Si rib is formed by dry-etching, leaving a 444 nm thick Si slab. (b) Effective index versus waveguide width in the 56 nm rib Si waveguide.

The waveguide is quasi-single mode within the yellow colored region. Inset: Electric field profile of the fundamental mode in 1.8  $\mu\text{m}$  wide waveguide.

## 2.2. Waveguide Loss Consideration

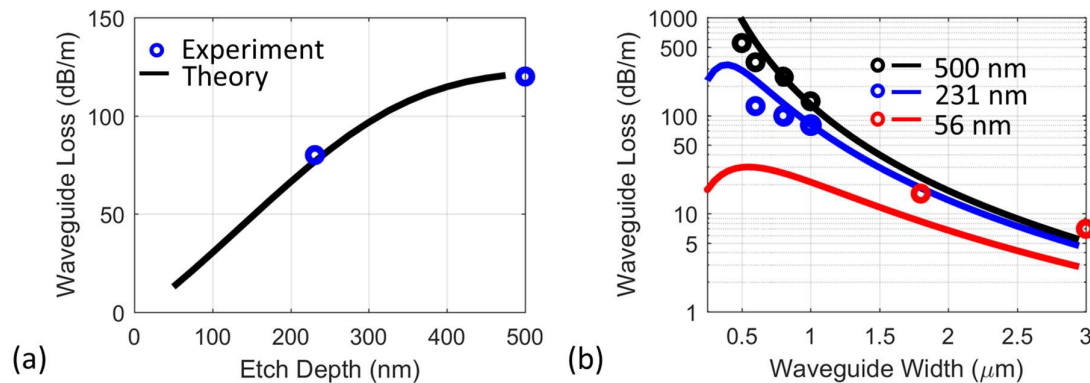
Due to the line-edge roughness associated with optical lithography, which is further aggravated in dry-etching processes, the propagation loss of the planar waveguides is typically dominated by the radiative loss induced by the interaction between the optical mode and the roughness on the waveguide sidewalls. Here, we estimate the waveguide radiative loss using the  $n_w$  model approximation [24]. This approximation is particularly useful if one only needs to quantify the relative comparisons of the propagation losses among different waveguide geometries under the same fabrication conditions. According to this model, waveguide loss can be approximated as

$$\alpha_r = A \left( \sigma, L_c, n_{\text{eff}} \right) \frac{\partial n_{\text{eff}}}{\partial w} \quad (1),$$

where  $A$  is the proportionality factor determined by the sidewall

roughness rms ( $\sigma$ ) and the roughness correlation length ( $L_c$ ),  $n_{\text{eff}}$  is the effective index of the waveguide optical mode, and  $w$  is the width of the waveguide. A full expression of  $A$  can be found in [25]. Given a waveguide geometry that is far from mode cut-off condition, the magnitude of the factor  $A$  in general does not depend on the waveguide width.

**Figure 2a** shows the measured propagation loss of the two “conventional” silicon waveguide geometries for the heterogeneous silicon platform used in previous works [9,26,27]. One is a fully 500 nm etched strip waveguide, and the other is 231 nm etched rib waveguide. The widths of both waveguides are 1  $\mu\text{m}$ . An empirical value of the parameters of the roughness parameters were obtained by fitting and then equation (1) is applied again to generate theoretical curve corresponding to the radiative losses at varying etch depth. The theoretical waveguide loss curves with varying etching depths (500 nm, 231 nm and 56 nm) are then calculated and plotted in **Figure 2b**, showing a reasonable agreement with experimental data. Low propagation loss in the range of 3-10 dB/m can be expected for the 56 nm rib silicon waveguides with larger than 1.5  $\mu\text{m}$  width.



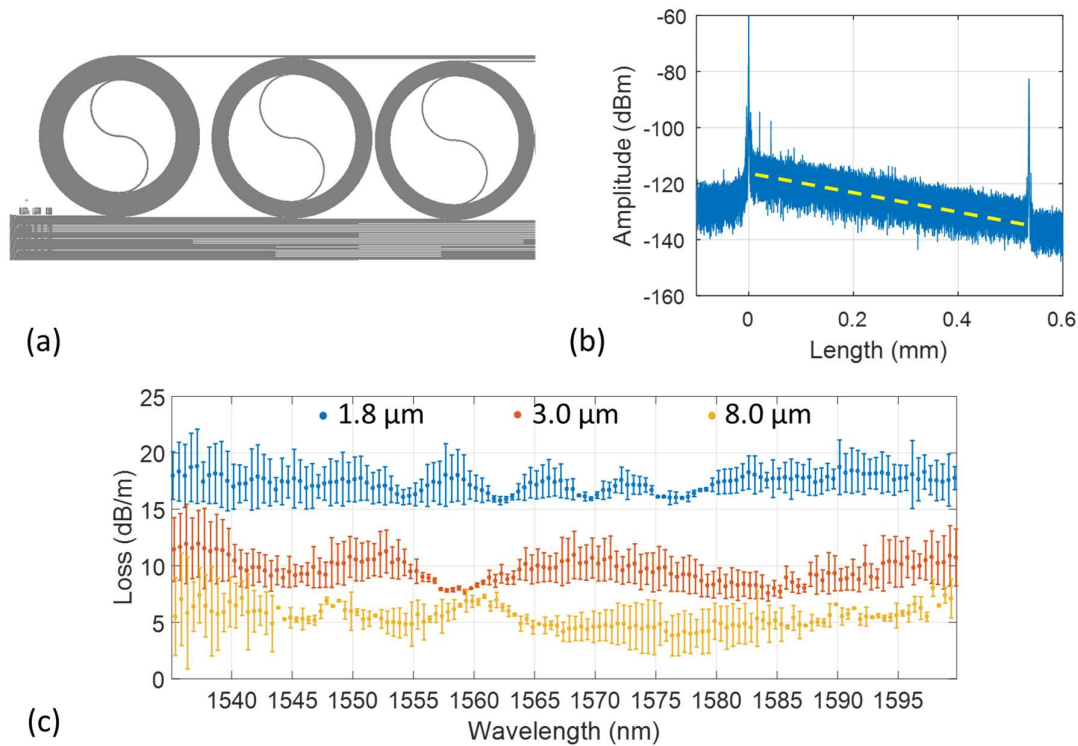
**Figure 2** (a) Experimental data (circular markers) and theoretical curve (solid line) for the propagation loss of 1  $\mu\text{m}$  wide waveguide at varying etch depth. (b) Theoretical calculations (solid lines) of the waveguide loss at varying waveguide width at three different etch depth (500 nm, 231 nm and 56 nm). The experimentally measured results are plotted in circular markers.

## 3. Passive Device Demonstrations

### 3.1. Long Waveguide Delay-line

We designed 52.2 cm long spiral delays illustrated in the **Figure 3a** to characterize the waveguide loss. Waveguide widths were 1.8, 3.0 and 8.0  $\mu\text{m}$  and the minimum bend radius used in all spirals

was 800  $\mu\text{m}$ . We use the coherent optical frequency domain reflectometry (OFDR) technique with a commercially available system (Luna Inc. OBR 4400) [28] to quantify the propagation loss of the fabricated Si rib waveguides. The technique has been proven to calculate the propagation loss with high accuracy independent of the fiber-waveguide coupling loss uncertainty [16]. **Figure 3b** shows the data measured for the 52.2 cm long spiral of 1.8  $\mu\text{m}$  wide Si waveguide. The peaks on the left hand side (near 0 m distance) and right hand side (near 0.5 m distance) are the reflections at the waveguide facets. The linearity of the trace verifies that the waveguide loss is not bend-loss limited. The measured mean and deviation of spectral dependence of the propagation loss of the three waveguide widths are plotted in **Figure 3c**. A single mode 1.8  $\mu\text{m}$  wide waveguide achieves an average of 16 dB/m propagation loss over C+L band. The loss rates in multimode waveguide with 3.0  $\mu\text{m}$  and 8.0  $\mu\text{m}$  widths are lower, at 10 dB/m and 4 dB/m respectively.



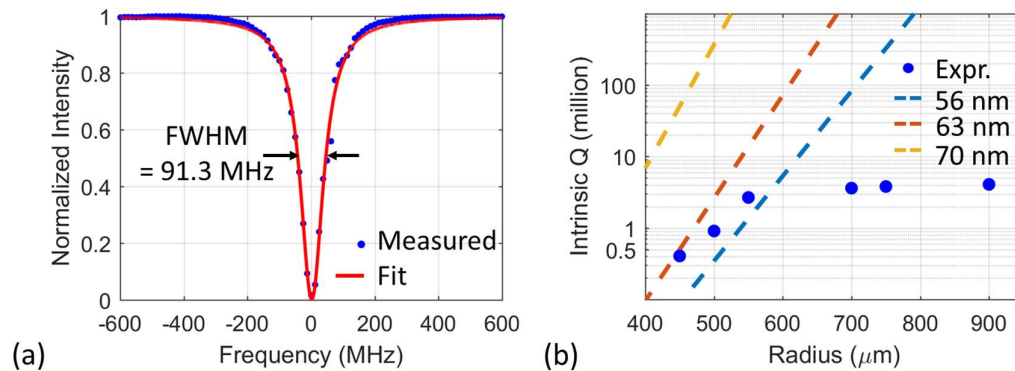
**Figure 3** (a) Mask layout of spiral delay lines with 52.2 cm total length and 850  $\mu\text{m}$  minimum bend radius (b) Optical Backscatter Reflectometry (OBR) data from the spiral with 1.8  $\mu\text{m}$  width. A linear fit of the waveguide backscatter is shown with the dashed red line. The propagation loss of the waveguide can be approximated as 1/2 of the slope of the fitted line. (c) Wavelength dependence of the propagation loss (mean and standard deviation) of waveguides with different widths (1.8  $\mu\text{m}$ , 3.0  $\mu\text{m}$  and 8.0  $\mu\text{m}$ ).

### 3.2. High Quality Factor Ring Resonators

One key component made possible by low-loss waveguides is the high-Q ring resonator. Ring resonators are an essential building block to realize compact optical filters and delays on chip. Higher Q-factors enable sharper, narrowband filters and longer delays, which are requirements for the aforementioned ultra-long laser cavity. There has been a plethora of recent work to demonstrate high-Q integrated resonators using different materials and cavity geometries. These results include fully integrated resonators with an intrinsic Q of 22 million in silicon [21], 81 million in a silicon nitride resonator [29] and over 200 million in a silica resonator [30]. However, the latter two results are multimoded, which can lead to multiple sets of resonances or excess loss at the coupling regions unless special care is taken to optimize the coupler [31]. These three results all have bend radii  $> 2\text{mm}$ , which limits the compactness of the device, and complicates the design of a Vernier-effect filter due

to the small free spectral range of each ring. Finally, it is unlikely that these resonators were designed with laser integration in mind, and cannot be integrated with the heterogeneous silicon/III-V laser without significant extra processing [20,32].

In this work, we demonstrate ring resonators readily integratable with the heterogeneous silicon/III-V platform with a loaded Q of 2.1 million, and an intrinsic Q of 4.1 million. The ring is in an all-pass configuration, and is 1.8 microns in width, which is single-mode for the TE polarization. The ring is connected to a bus waveguide of the same dimensions using a straight-to-curved coupler with a 1.2 micron coupling gap. The transmission spectra of the ring is measured by sweeping a high-resolution tunable laser (0.1 pm steps) across the resonance, and measuring the output power. The resulting spectra is depicted in **Figure 4a**, and fitted with a Lorentzian function. The measured full width half max (FWHM) is 91.3MHz.



**Figure 4.** (a) Measured spectral responses of the 750  $\mu\text{m}$  radius Si ring resonator (all-pass configuration) plotted with a Lorentzian fit. The extracted intrinsic quality factor  $Q_{\text{int}} = 4.1$  million. (b) Simulated bend-loss limited intrinsic Q of the rings versus ring radius at three etch depths. The experimental data of the targeted 56 nm etch depth are depicted as blue circular markers.

The ring in **Figure 4a** has a 750  $\mu\text{m}$  bend radius, for which we did not observe any bend-loss induced radiation in the resonator. To confirm this, we investigated rings with varying radii, and plot their intrinsic Q factor alongside the theoretical bend-loss limit for Q in **Figure 4b**. The experimental results are extracted from the measured FWHM, while the dotted lines are simulated using Lumerical MODE solutions. The simulations are shown for three different etch depths, as that is the most sensitive parameter to the bend-loss. We find that our ring in this experiment is actually overetched compared the target 56 nm, judging by the Q of the smaller rings. We do not observe significant bend loss in the rings until the radius is less than 550 nm. For practical reasons, the ring radius should be larger than 700 nm to avoid bend-loss possibly caused by an underetch of the waveguide.

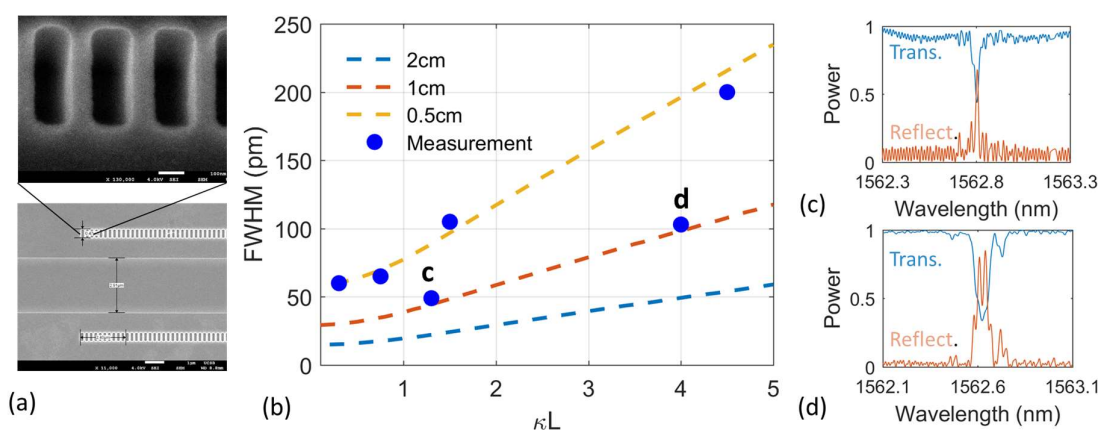
### 3.3. Narrow Bandwidth Bragg Gratings

Another useful component that can be realized with low-loss waveguides is a low-kappa ( $\kappa$ ) Bragg grating. These gratings are widely used in filters, sensors, and semiconductor lasers as a wavelength selective element, much like the ring resonator. The bandwidth of the grating is directly proportional to power coupling coefficient  $\kappa$ , and therefore can be minimized by reducing the perturbation strength of the grating [33]. At the same time, the length (L) of the grating should be long enough ( $\kappa L \sim 1$ ) and the loss of the waveguide must be low in order to obtain sufficient reflection. Care must be taken in the design of the grating in order to achieve weak  $\kappa$  as conventional sidewall or top surface gratings tend to have stronger  $\kappa$ . Instead, we utilize “post” (or inversely, “hole”) gratings in which small areas of the waveguiding material are placed (removed) periodically on either side of the waveguide. The dimensions of the posts (holes) and proximity to the waveguide can be lithographically defined, and tailored to achieve the desired  $\kappa$ . This approach has been



successful for low loss silicon nitride gratings [34]. For our waveguides, it is simpler to etch holes on either side of the waveguide, as shown in **Figure 5a**. The resulting  $\kappa$  of the grating is directly controlled by the hole-to-waveguide distance, while the period of the grating is set to be 240 nm, corresponding to a stopband at 1563 nm for an unperturbed waveguide  $n_{\text{eff}} = 3.256$ .

We fabricate uniform gratings with lengths of 0.5 and 1.0 cm. The waveguide width is 1.8  $\mu\text{m}$ , and the length is 2.2 cm. We used an e-beam lithography to write the grating teeth, although DUV immersion lithography can also resolve 120 nm features. Transmission and reflection spectra are measured, and fitted using a transfer matrix model in Lumerical Interconnect. This approach also accounts for Fabry-Perot cavities formed by the waveguide facets, which affects the grating shape. From this, we extract the bandwidth and peak reflectivity of the grating, which can then be used to estimate  $\kappa$ . A few selected gratings are depicted in **Figure 5b** along with the predicted grating bandwidth. Using 1cm long gratings, we were able to achieve a 50 pm FWHM bandwidth with roughly 70% reflectivity, with potential to further reduce the bandwidth with a longer grating.



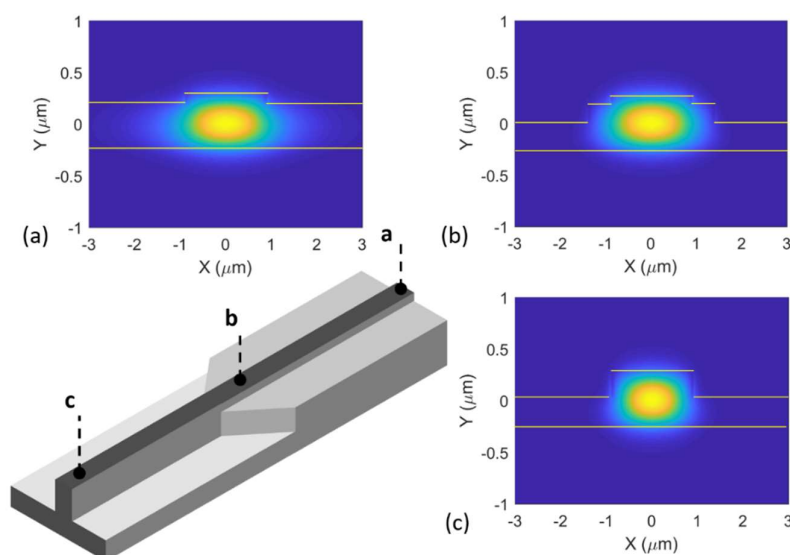
**Figure 5.** (a) An SEM image of the fabricated low  $\kappa$  Bragg grating waveguide with a close-up of the holes on both sides of the waveguide. (b) Theoretical calculations of gratings' full width half max (FWHM) versus varying  $\kappa L$  for 0.5, 1 and 2 cm long grating waveguides. Circular blue markers show the measured data. (c-d) Spectra of reflection and transmission of 1 cm long grating waveguides with  $\kappa = 1.25 \text{ cm}^{-1}$  and  $\kappa = 4.0 \text{ cm}^{-1}$ , respectively. The ripples are caused by reflections off the waveguide facets.

#### 4. Photonic Integrated Circuits with Ultralow Loss Silicon Waveguides

The ability to integrate ultralow loss waveguides inside the laser cavity or form fully integrated delay lines with active devices promises vastly superior performance at much reduced footprint compared to e.g. fiber-based delays. Furthermore, full integration improves the robustness of devices and reduces cost of packaging. The key for integration is a low loss taper to transition from ULL waveguides to a waveguide geometry with smaller bend radius, which we describe in detail in following section. This allows us to expand the versatility of the heterogeneous silicon platform. Finally, we give two applications that benefit greatly from having ULL waveguides: narrow linewidth lasers and interferometric optical gyroscopes.

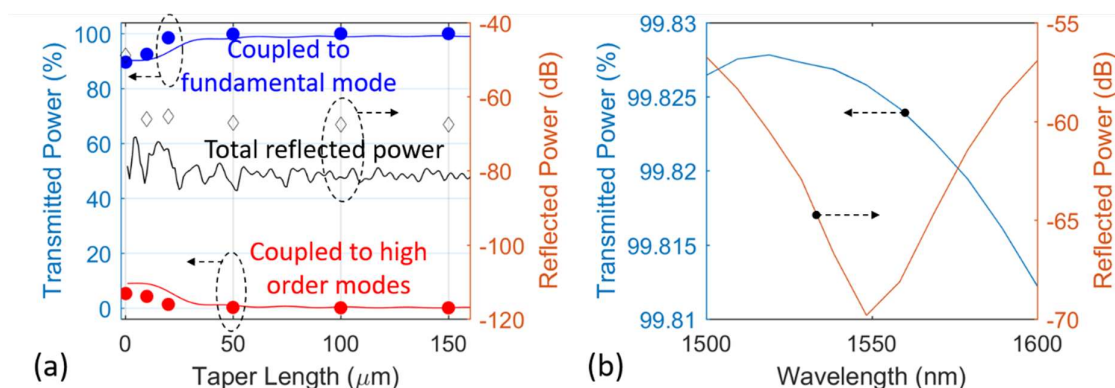
##### 4.1. Transition Taper to Standard Silicon Waveguides

**Figure 6** shows the schematic of an adiabatic taper for a low loss, low reflection transition of the optical mode from the 56 nm etched rib ULL waveguide to a deeper 231 nm etched rib waveguide, which has a smaller bend radius (50  $\mu\text{m}$ ). The waveguide width is set at 1.8  $\mu\text{m}$ . The mode transition happens along the linear taper formed by etching on the Si slab. **Figure 6** (a-c) shows the simulated profiles of the waveguide's fundamental mode at points a, b and c denoted on the schematic figure.



**Figure 6.** Schematic of the taper converting the optical mode from an ULL waveguide to standard rib (231 nm etch depth) waveguide. Figures (a), (b) and (c) show the waveguide mode profiles at locations labeled a – ULL silicon waveguide, b – central part of the taper, and c - standard silicon waveguide along the taper structure.

In order to ensure an adiabatic transition from fundamental mode of the 56 nm etched waveguide to the 231 nm etched waveguide, the length of the linear taper must be sufficiently long. As shown in **Figure 7a**, at 1550 nm wavelength, high order modes in the deeper rib waveguide are excited if the taper length is shorter than 25  $\mu\text{m}$ . With a taper longer than 50  $\mu\text{m}$ , both mode expansion and FDTD simulations show that essentially 100% transmission in the fundamental mode is achieved. The reflection power is also simulated and is shown to be lower than -60 dB level. To be safe, the taper length of 200  $\mu\text{m}$  is chosen in practice. The wavelength dependence of the transmission efficiency and reflection power are again simulated in FDTD and shown in **Figure 7b**. Larger than 99.8% transmission and lower than -55 dB reflection should be achievable over the whole C+L band.



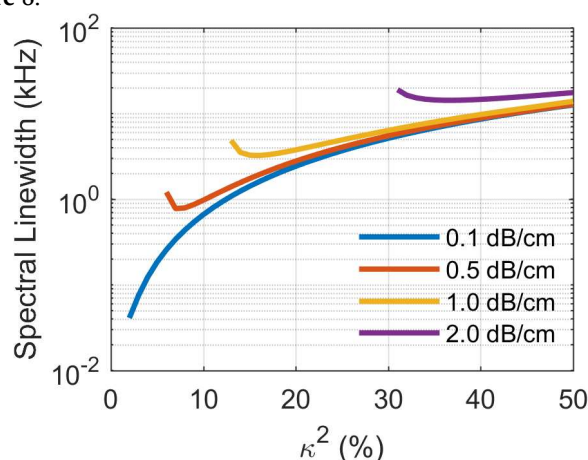
**Figure 7.** (a) Simulation results at 1550 nm wavelength of the optical transmissions and reflections at the deep-shallow taper. The fundamental mode was launched from the ULL silicon waveguide side. Transmitted and reflected powers to the fundamental mode and high order modes were simulated using two methods. The solid lines show the results using mode expansion on the PhotoDesign FimmProp, while the markers are the data points simulated with Lumerical FDTD (b) Wavelength dependence of the transmission and reflection from fundamental input mode to fundamental output mode, simulated with Lumerical FDTD.

## 4.2. Applications

### 4.2.1. Extended Cavity Lasers

The heterogeneous silicon platform has demonstrated superior laser linewidth performance compared to typical linewidths of III/V lasers that are in a few MHz range [35]. There are at least two reasons for superior linewidth. The platform allows for the control of confinement in the quantum wells and provides a low-loss waveguide platform, opening a new possibility in improving the coherence by providing a mechanism to separate the photon resonator (in silicon) and highly-absorbing active medium [36]. The second improvement comes due to the use of ring resonators inside the laser cavity to realize widely-tunable laser. Ring resonators, provided that the utilized waveguide platform offers sufficiently low propagation losses, have an advantage as the effective cavity length at ring resonance is significantly enhanced, directly reducing linewidth. Both reasons benefit from loss reduction, and it was predicted that sub-kHz Lorentzian linewidths should be attainable with waveguide platform providing sub-0.5 dB/cm propagation loss [37].

We extend the analysis to platform providing 0.1 dB/cm propagation and keep the same basic laser structure as in [37] comprising of three ring resonators inside the Fabry-Perot laser cavity. The estimated Lorentzian linewidth for optimized laser fabricated with such low-loss waveguides is sub-100 Hz as shown in **Figure 8**.



**Figure 8.** Simulated Lorentzian linewidth of widely-tunable laser comprising of three rings as a function of coupling strength of the high-Q ring for four waveguide propagation loss scenarios. The analysis ignores non-linear effects.

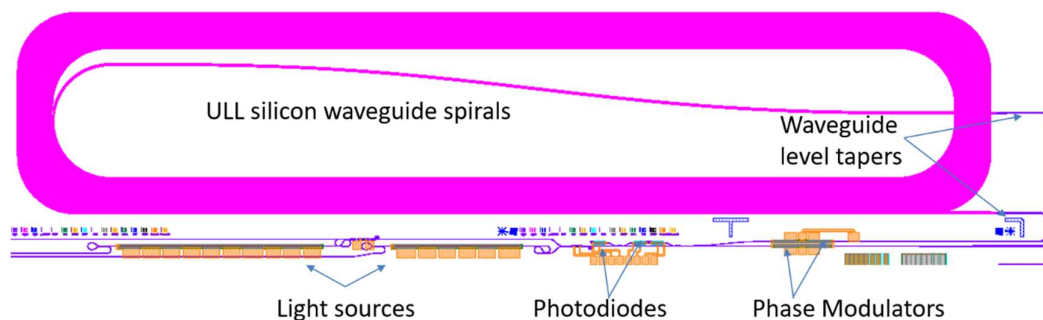
#### 4.2.2. Optical Gyroscopes

Small SWAP and low cost gyroscopes are of great importance in the fields of radar, robotics and automobiles and recently has rapidly become even more so with the emergence of augmented reality technology and drones. In many applications that operate in environments with high shocks and vibrations, optical gyroscopes are more robust and reliable compared to their MEMS counterparts because they do not have any moving parts. However, the large size and cost of traditional optical gyroscopes, which are based on discrete components, make them difficult to be as widely usable as MEMS gyros. In a previous work [9], we have used integrated silicon photonics to miniaturize the optical driver (OD) part for interferometric fiber gyroscopes (IFOGs) to a small chip. The integrated OD chip contains every optical component needed for the gyroscope, except the fiber sensing coil which needs to be sufficiently long to achieve high sensitivity. For applications that require lower sensitivity, however, an integrated waveguide-based delayline might deliver adequate performance. In the following, we show the architecture of an interferometric optical gyroscope fully integrated on silicon, making use of the ULL Si waveguide as its Sagnac sensing coil.

The schematic mask layout of the integrated gyroscope is shown in **Figure 9**. The general architecture of the circuit is very similar to [38]: The light from the sources goes through two 3-dB broadband couplers to get splitted into two waves and then go through push-pull phase modulators. The two waves enter the ULL silicon waveguide sensing coil (with 4 dB/m propagation loss) and

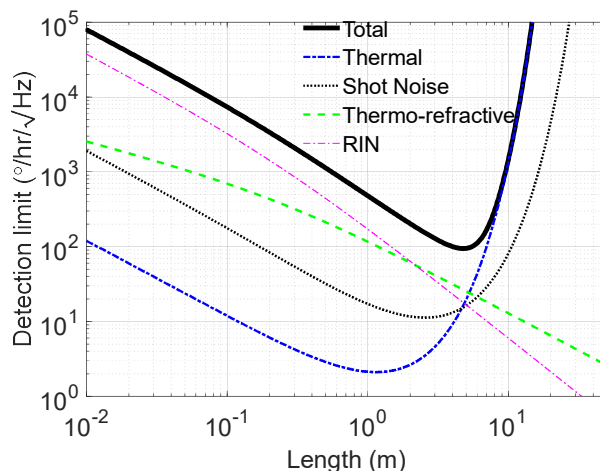


propagate in counter-directions before coming back to beat on a photodiode on a port of the first 3-dB coupler. The Sagnac phase shift can be detected and used to measure the rotation of the system.



**Figure 9.** Schematic mask layout of an integrated interferometric optical gyroscope on heterogeneous silicon photonics. The sensing parting of the gyroscope is the four-meter long ULL silicon waveguide spiral with propagation loss  $\sim 4$  dB/m. The sensing coil waveguides were connected with a compact integrated optical driver ([9]) via tapers to standard and compact waveguides.

The sensitivity of the proposed gyroscope as a function of the length of the Sagnac waveguide coil is estimated by taking into account four sources of noise, i.e. thermal noise, shot noise, relative intensity noise and thermo-refractive noise. The analysis is performed in the same manner in our previous work [38] and the contribution from each noise term to rotation noise spectral density are depicted in **Figure 10**. A 50 mW output power from the light sources, 4 dB/m loss in the ULL silicon waveguide coil, and 0.02 dB/crossing (simulated value) were assumed. The minimum detection limit of the gyroscope is approximated to be  $113^\circ/\text{hr}/\sqrt{\text{Hz}}$ .



**Figure 10.** Contributions from various noise sources to the rotation noise spectral density as a function of Sagnac loop length for optical output power  $P_0 = 100\text{mW}$  and waveguide propagation loss = 4 dB/m. Calculations were based on the analysis presented in [38].

## 5. Conclusion

In conclusion, we have demonstrated ULL silicon waveguides using 500 nm thick SOI that can be seamlessly integrated with heterogeneous silicon/III-V active components such as lasers, modulators, and photodetectors. Waveguide loss is as low as 4 dB/m for a multimode waveguide, and 16 dB/m for a quasi-single mode waveguide. The ultralow loss directly benefits applications such as optical gyroscopes in which a long delay line is needed. It can also be utilized in high-Q ring

resonators and narrowband grating-based filters. We demonstrate rings with 4.1 million intrinsic Q, which are promising to realize narrow linewidth lasers on silicon. Calculations show that linewidths on the order of 100 Hz should be achievable using these waveguides.

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**Author Contributions:** M.T. designed the devices; M.T., D.H. performed the experiments; M.T., D.H., T.K. simulated and analyzed the data; J.P., A.M, D.H. fabricated the devices; M.T., D.H., T.K., J.B. wrote the manuscript; J.B. supervised the project.

**Conflicts of Interest:** The authors declare no conflict of interest.

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